

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT78 plastic package intended for use in applications requiring high bidirectional blocking voltage capability, high surge current capability and high thermal cycling performance.

2. Features and benefits

- High bidirectional blocking voltage capability
- High surge current capability
- High thermal cycling performance

3. Applications

- Ignition circuits
- Motor control
- Protection circuits
- Voltage regulation

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DRM}	repetitive peak off- state voltage		-	-	800	V
V _{RRM}	repetitive peak reverse voltage		-	-	800	V
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4</u> ; <u>Fig. 5</u>	-	-	120	A
		half sine wave; $T_{j(init)} = 25 \text{ °C};$ $t_p = 8.3 \text{ ms}$	-	-	132	A
Tj	junction temperature		-	-	125	°C
I _{T(AV)}	average on-state current	half sine wave; $T_{mb} \le 109 \text{ °C}$; Fig. 1	-	-	7.5	A
I _{T(RMS)}	RMS on-state current	half sine wave; $T_{mb} \le 109 \text{ °C}$; <u>Fig. 2</u> ; <u>Fig. 3</u>	-	-	12	A
Static chara	acteristics	·			·	
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	2	15	mA
Dynamic ch	naracteristics	· · · · ·		1		

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV _D /dt	rate of rise of off-state voltage	$\label{eq:DM} \begin{array}{l} V_{DM} = 536 \text{ V}; \text{T}_{\text{j}} = 125 \ ^{\circ}\text{C}; \text{R}_{\text{GK}} = 100 \ \Omega; \\ (\text{V}_{DM} = 67\% \ \text{of } \text{V}_{DRM}); \text{ exponential} \\ \text{waveform}; \ \overline{\text{Fig. 12}} \end{array}$	200	1000	-	V/µs

5. Pinning information

Table 2. Pinning information						
Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	К	cathode	mb	A - D K		
2	А	anode		G sym037		
3	G	gate		Syntosi		
mb	A	mounting base; connected to anode				
			TO-220AB (SOT78)			

6. Ordering information

Table 3. Ordering information

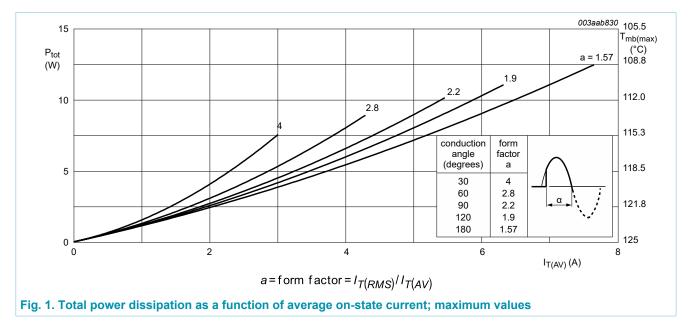
Type number	Package				
	Name	Description	Version		
BT151-800R	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

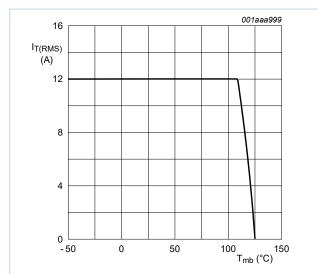
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
V _{RRM}	repetitive peak reverse voltage		-	800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 109 °C; <u>Fig. 1</u>	-	7.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; $T_{mb} \le 109 \text{ °C}$; <u>Fig. 2</u> ; Fig. 3	-	12	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	120	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	-	132	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	72	A²s
dl _T /dt	rate of rise of on-state current	I _G = 30 mA	-	50	A/µs
I _{GM}	peak gate current		-	2	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C

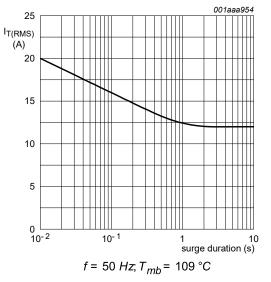


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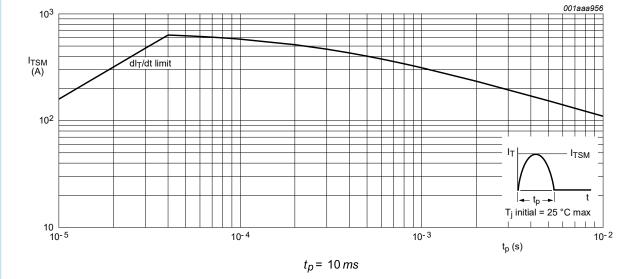
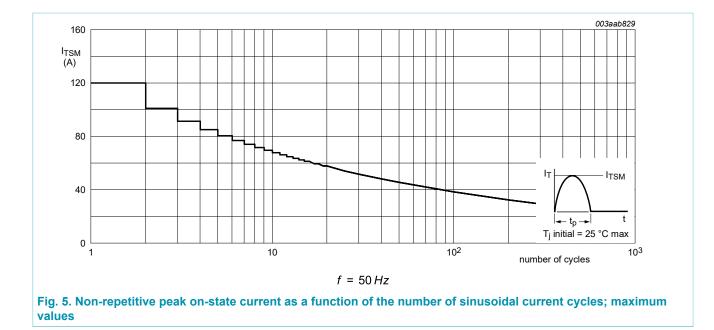


Fig. 4. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

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8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>6</u>	-	-	1.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

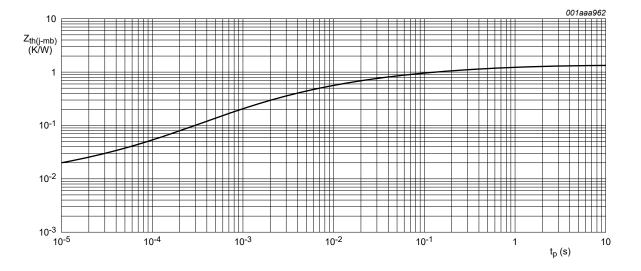


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

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9. Characteristics

Symbol	Parameter	Conditions	Mir	Тур	Max	Unit
Static chara	acteristics	· · · · · · · · · · · · · · · · · · ·				
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	2	15	mA
IL	latching current	V _D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>	-	10	40	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	7	20	mA
V _T	on-state voltage	I _T = 23 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.4	1.75	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	0.6	1.5	V
		V_D = 800 V; I _T = 0.1 A; T _j = 125 °C; Fig. 11	0.2	5 0.4	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C	-	0.1	0.5	mA
I _R	reverse current	V _R = 800 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic ch	aracteristics		· · · ·	·		
dV _D /dt	rate of rise of off-state voltage	$ V_{DM} = 536 \text{ V}; \text{T}_{\text{j}} = 125 ^\circ\text{C}; \text{R}_{\text{GK}} = 100 \Omega; \\ (\text{V}_{\text{DM}} = 67\% \text{ of } \text{V}_{\text{DRM}}); \text{ exponential} \\ waveform; \underline{\text{Fig. 12}} $	200	1000	-	V/µs
		V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12	50	130	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 40 A; V _D = 800 V; I _G = 0.1 A; dI _G / dt = 5 A/µs; T _j = 25 °C	-	2	-	μs
t _q	commutated turn-off time	V_{DM} = 536 V; T _j = 125 °C; I _{TM} = 20 A; V_R = 25 V; (dI _T /dt) _M = 30 A/µs; dV _D / dt = 50 V/µs; R _{GK(ext)} = 100 Ω; (V _{DM} = 67% of V _{DRM})	-	70	-	μs

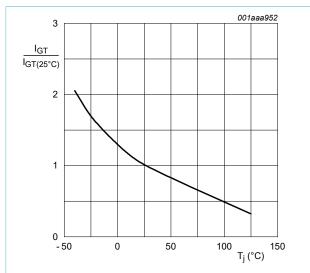


Fig. 7. Normalized gate trigger current as a function of junction temperature

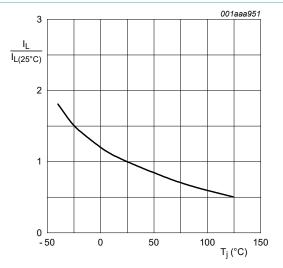
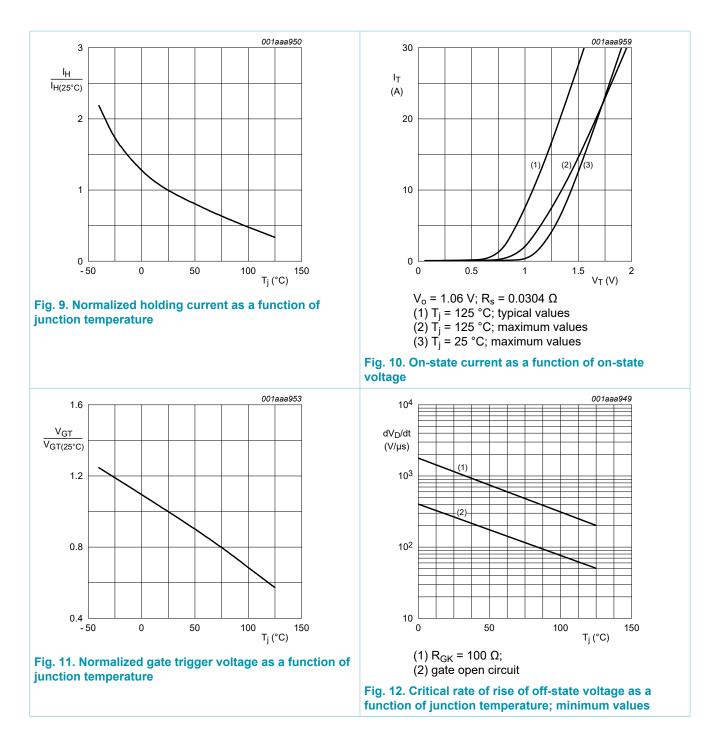


Fig. 8. Normalized latching current as a function of junction temperature

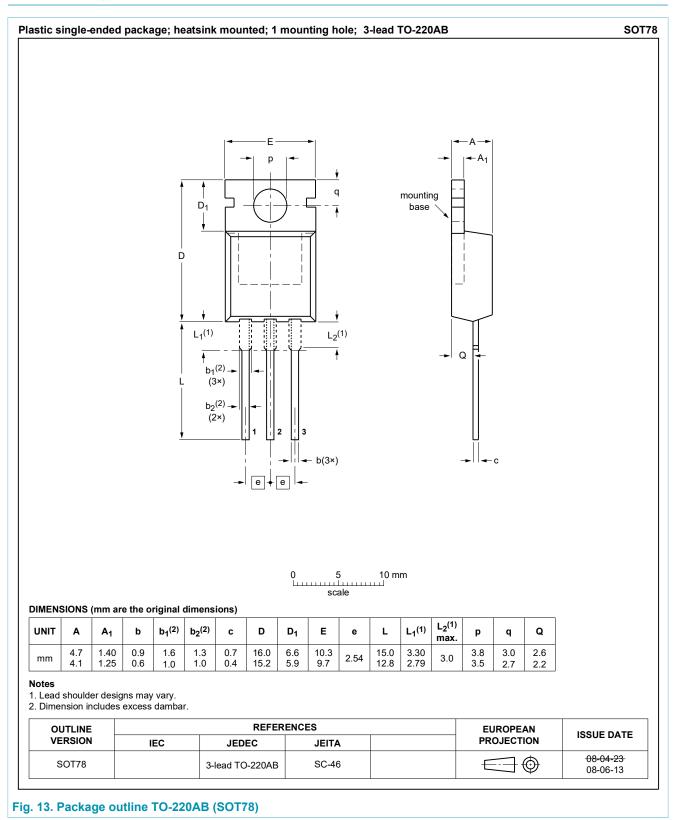
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10. Package outline



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11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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